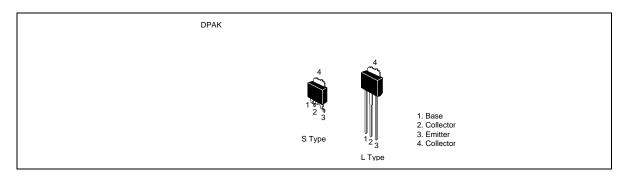
Silicon NPN Epitaxial Planar

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Application

Low frequency power amplifier

Outline



Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Rating	Unit V	
Collector to base voltage	V _{cbo}	150		
Collector to emitter voltage	V _{ceo}	60	V	
Emitter to base voltage	V _{ebo}	5	V	
Collector current	I _c	2	А	
Collector peak current	I _{C(peak)}	2.5	А	
Collector power dissipation	P _c * ¹	18	W	
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

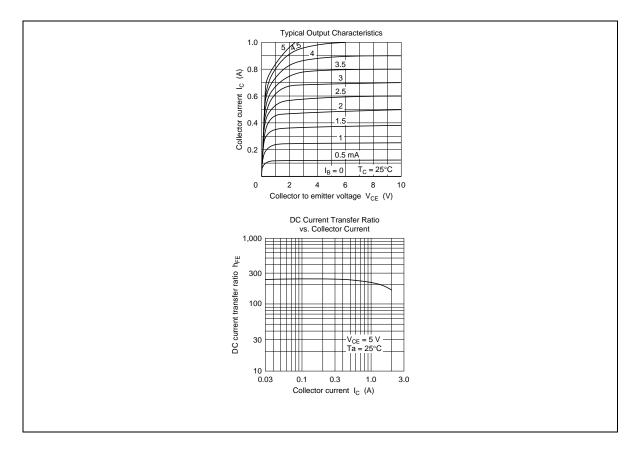
Note: 1. Value at $T_c = 25^{\circ}C$.

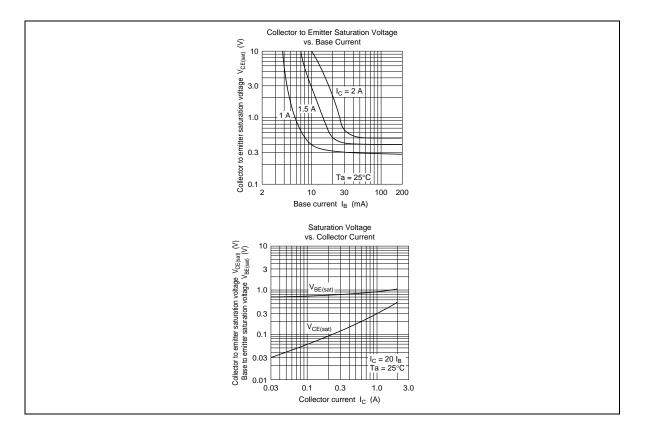
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	150	—	_	V	$I_{c} = 1 \text{ mA}, I_{e} = 0$
Collector to emitter breakdown voltage	$V_{\scriptscriptstyle (BR)CEO}$	60	—	_	V	$I_c = 10 \text{ mA}, \text{ R}_{\scriptscriptstyle BE} = \infty$
Emitter to base breakdown voltage	$V_{\scriptscriptstyle (BR)EBO}$	5	—	_	V	$I_{e} = 1 \text{ mA}, I_{c} = 0$
Collector cutoff current	I _{сво}	_	_	10	μA	$V_{_{CB}} = 100 \text{ V}, \text{ I}_{_{E}} = 0$
DC current transfer ratio	h _{FE}	150	_	_		$V_{ce} = 5 \text{ V}, \text{ I}_{c} = 1.5 \text{ A}^{*1}$
Collector to emitter saturation voltage	$V_{_{CE(sat)}}$	—	_	0.8	V	$I_{c} = 1.5 \text{ A}, I_{B} = 0.05 \text{ A}^{*1}$
Base to emitter saturation voltage	$V_{\scriptscriptstyle BE(sat)}$	—	—	1.3	V	$I_c = 1.5 \text{ A}, I_B = 0.05 \text{ A}^{*1}$
Fall time	t _r	_	_	0.6	μs	$I_{c} = 1.5 \text{ A}, I_{B1} = -I_{B2} = 50 \text{ mA}$
Note: 1. Pulse test.						

Maximum Collector Dissipation Curve 30 Collector power dissipation $\, P_{C} \, \left(W \right) \,$ 01 $\,$ 02 $\,$ 0 150 50 100 Case temperature $\mbox{ T}_C \ (^\circ C)$ Area of Safe Operation 3.0 - i_{C(peak)} I_{C(max} Collector current I_C (A) 1.0 0.3 0.1 Ta = 25°C, 1 shot pulse 0.03 3 10 30 100 1 Collector to emitter voltage $~V_{CE}~~(V)$

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